Unit: mm

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TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSII)

2SK3662

Switching Regulator, DC-DC Converter, Motor Drive Applications

• Low drain-source ON resistance: RDS (ON) = 9.4 m Ω (typ.)

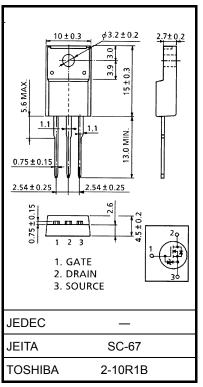
• High forward transfer admittance: $|Y_{fs}| = 55 \text{ S (typ.)}$

• Low leakage current: $I_{DSS} = 100 \mu A \text{ (max) (V}_{DS} = 60 \text{ V)}$

• Enhancement mode: $V_{th} = 1.3 \text{ to } 2.5 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA)}$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	60	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	60	V	
Gate-source voltage		V _{GSS}	±20	٧	
Drain current	DC (Note 1)	I _D	35	Α	
	Pulse (Note 1)	I _{DP}	105		
Drain power dissipation (Tc = 25°C)		P_{D}	35	W	
Single pulse avalanche energy (Note 2)		E _{AS}	204	mJ	
Avalanche current		I _{AR}	35	Α	
Repetitive avalanche energy (Note 3)		E _{AR}	3.5	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	



Weight: 1.9 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to case	R _{th (ch-c)}	3.57	°C/W	
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W	

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = 25 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), $L = 227 \mu\text{H}$, $I_{AR} = 35 \text{ A}$, $R_G = 25 \Omega$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.



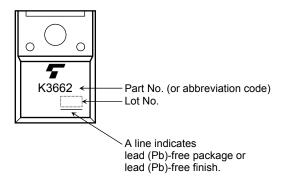
Data Sheet 4 IJ. com Electrical Characteristics (Ta = 25°C)

Cha	aracteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА	
Drain cut-off curre	ent	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	_	_	100	μА	
Drain-source breakdown voltage		V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	60	_	_	V	
		V (BR) DSX	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	40				
Gate threshold voltage		V _{th}	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$	1.3	_	2.5	V	
Drain-source ON resistance		R _{DS} (ON)	V _{GS} = 4 V, ID = 18 A	_	12.5	19	- mΩ	
			V _{GS} = 10 V, I _D = 18 A	_	9.4	12.5		
Forward transfer admittance		Y _{fs}	V _{DS} = 10 V, I _D = 18 A	28	55		S	
Input capacitance		C _{iss}		_	5120		pF	
Reverse transfer capacitance		C _{rss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	300	_		
Output capacitance		Coss		_	500	_		
Switching time	Rise time	t _r	O V O T O T O T O T O T O T O T O T O T	_	6	_	- ns	
	Turn-on time	t _{on}		_	19	_		
	Fall time	t _f		_	20	_		
	Turn-off time	t _{off}	V _{DD} ≈ 30 V Duty ≤ 1%, t _w = 10 μs	_	115	_		
Total gate charge (gate-source plus gate-drain)		Qg	V _{DD} ≈ 48 V, V _{GS} = 10 V,	_	91	_	nC	
Gate-source charge		Q _{gs}	$I_D = 35 \text{ A}$	_	70	_		
Gate-drain ("miller") charge		Q _{gd}		_	21	_		

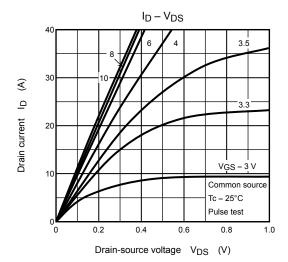
Source-Drain Diode Ratings and Characteristics (Ta = 25°C)

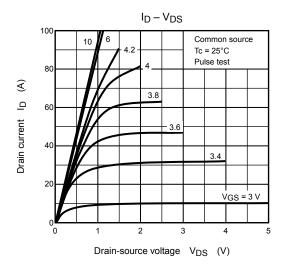
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	35	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	105	Α
Forward voltage (diode)	V _{DS2F}	I _{DR1} = 35 A, V _{GS} = 0 V	_	_	-1.5	V
Reverse recovery time	t _{rr}	$I_{DR} = 35 \text{ A}, V_{GS} = 0 \text{ V},$		60	_	ns
Reverse recovery charge	Q _{rr}	dl _{DR} /dt = 50 A/μs	_	58	_	nC

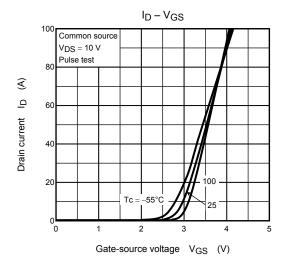
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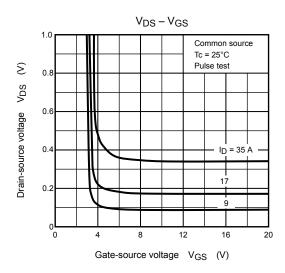


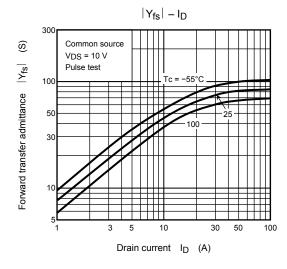
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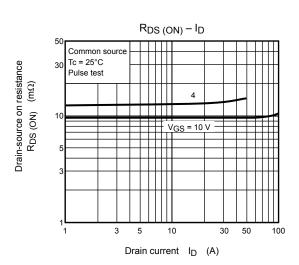




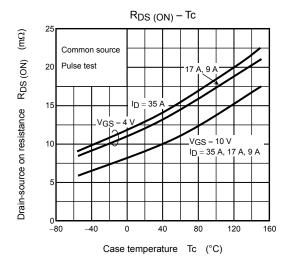


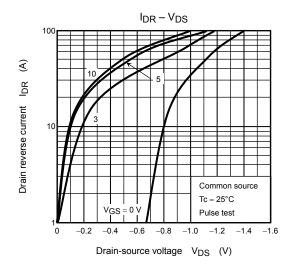


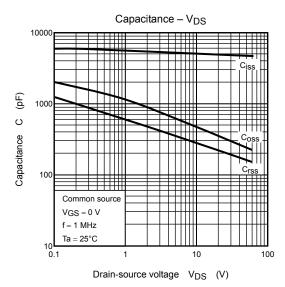


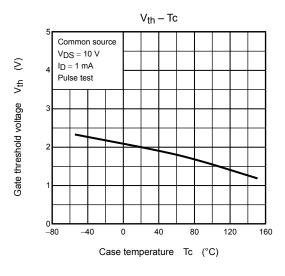


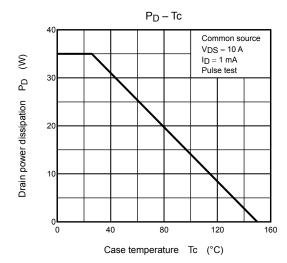
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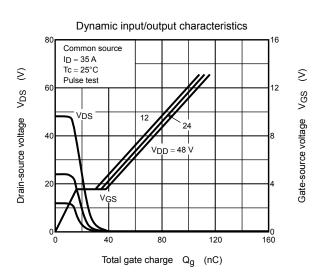




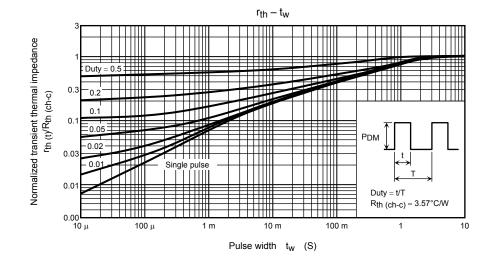


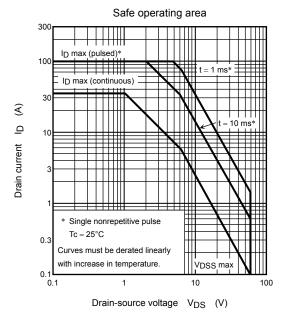


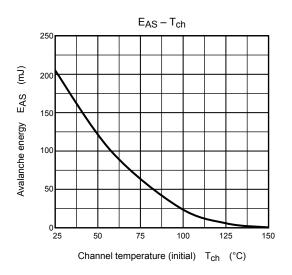


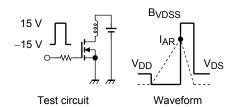


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$$\begin{aligned} R_G &= 25~\Omega \\ V_{DD} &= 25~V,~L = 227~\mu H \end{aligned} \qquad \text{EAS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{BVDSS}{BVDSS} - V_{DD} \right) \end{aligned}$$

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